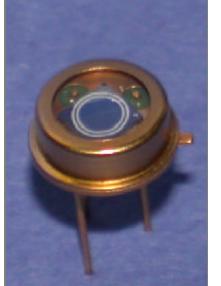
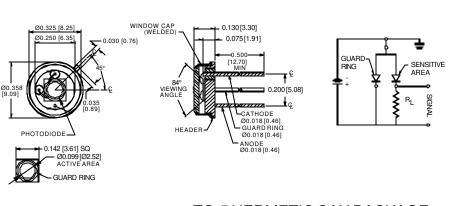
PHOTONIC <u>DETECTORS INC.</u>

1.06 Micron, High Speed Silicon Photodiode Type PDI-M301



PACKAGE DIMENSIONS INCH [mm]



TO-5 HERMETIC CAN PACKAGE

RESPONSIVITY (A/W)

ACTIVE AREA = 5.0 mm^2

FEATURES

- .45 A/W @1060 nm
- 11 ns response time
- Low noise

The **PDI-M301** is a high speed photodiode, processed on high resistivity P type silicon. Guard ring construction for enhanced 1060 nm response and 28 Mhz bandwidth. Packaged in a 3 leaded hermetic TO-5 hermetic package. Ideal for Nd YAG laser.

APPLICATIONS

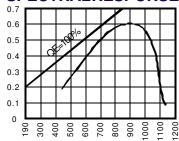
- YAG laser detection
- High speed IR sensor
- Optical pyrometer sensor

ABSOLUTE MAXIMUM RATING (TA=25°C unless otherwise noted) SYMBOL PARAMETER MIN MAX

DESCRIPTION

••••••				•
V _{BR}	Reverse Voltage		75	V
T _{STG}	Storage Temperature	-55	+125	S
T _o	Operating Temperature Range	-40	+100	с
Τ _s	Soldering Temperature*		+260	Ŷ
I _L	Light Current		500	mA

SPECTRALRESPONSE



WAVELENGTH(nm)

*1/16 inch from case for 3 secs max

ELECTRO-OPTICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	MIN	TYP	MAX	UNITS				
ا _{عد}	Short Circuit Current	H = 100 fc, 2850 K	40	60		μA				
I _D	Dark Current	$H = 0, V_{R} = 200 V$		9	16	nA				
R _{SH}	Shunt Resistance	$H = 0, V_{R} = 10 \text{ mV}$		100		MΩ				
TC R _{SH}	RSH Temp. Coefficient	H = 0, V _R = 10 mV		-10		% / °C				
CJ	Junction Capacitance	$H = 0, V_{R} = 200 V^{**}$		2.8	3.0	рF				
λrange	Spectral Application Range	Spot Scan	400		1150	nm				
λρ	Spectral Response - Peak	Spot Scan		900		nm				
VBR	Breakdown Voltage	I = 1 µµA	250	400		V				
NEP	Noise Equivalent Power	V _R = 10 V @ 900 nm		1.5x10 ⁻¹²		W/ V Hz				
tr	Response Time	$RL = 1 K\Omega V_R = 200 V$		11		nS				

Information in this technical data sheet is believed to be correct and reliable. However, no responsibility is assumed for possible inaccuracies or omission. Specifications are subject to change without notice. ** f = 1 MHz [FORM NO. 100-PDI-M301 REV C]